

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT3309557

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHINKO ELECTRIC INDUSTRIES CO., LTD.	01/28/2015
RECEIVING PARTY DATA	
Name:	SHINKO ELECTRIC INDUSTRIES CO., LTD.
Street Address:	80, OSHIMADA-MACHI
City:	NAGANO-SHI, NAGANO
State/Country:	JAPAN
Postal Code:	381-2287
Name:	JAPAN ELECTRONIC MATERIALS CORPORATION
Street Address:	2-5-13 NISHINAGASU-CHO
City:	AMAGASAKI-SHI, HYOGO
State/Country:	JAPAN
Postal Code:	660-0805
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14202701
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	DAVID E. SPAW
SIGNATURE:	/David E. Spaw/
DATE SIGNED:	04/14/2015
Total Attachments: 2	

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ASSIGNMENT

WHEREAS, SHINKO ELECTRIC INDUSTRIES CO., LTD., a corporation of Japan, located at 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan, has acquired the rights to U.S. Patent Application Serial No. 14/202701 (Rankin, Hill & Clark LLP Docket No. HKY-37872), entitled "PROBE GUIDE PLATE AND METHOD FOR MANUFACTURING THE SAME," hereinafter referred to as the Patent Application, by means of assignment from the inventors, Akinori Shiraishi et al., which assignment is recorded in the United States Patent Office on March 11, 2014, at Reel 32406, Frame 0997; and

WHEREAS, SHINKO ELECTRIC INDUSTRIES CO., LTD., a corporation of Japan, located at 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan and JAPAN ELECTRONIC MATERIALS CORPORATION, a corporation of Japan, located at 2-5-13 Nishinagasu-cho, Amagasaki-shi, Hyogo, 660-0805, Japan are desirous of acquiring the entire right, title and interest in and to said Patent Application;

NOW THEREFORE TO ALL WHOM IT MAY CONCERN, BE IT KNOWN THAT the said SHINKO ELECTRIC INDUSTRIES CO., LTD., for good and valuable consideration, the receipt and sufficiency of which from SHINKO ELECTRIC INDUSTRIES CO., LTD. and JAPAN ELECTRONIC MATERIALS CORPORATION are hereby acknowledged, has sold, assigned, transferred and conveyed, and by these presents sell, assign, transfer and convey unto said SHINKO ELECTRIC INDUSTRIES CO., LTD. and JAPAN ELECTRONIC MATERIALS CORPORATION, its successors and assigns, the entire right, title and interest in and to the said invention entitled "PROBE GUIDE PLATE AND METHOD FOR MANUFACTURING THE SAME," which invention is set forth and described in said Patent Application.

AND, the said SHINKO ELECTRIC INDUSTRIES CO., LTD., does hereby authorize and request the Commissioner of Patents to register said Patent Application and issue the corresponding Letters Patent of the United States in the name of said SHINKO ELECTRIC INDUSTRIES CO., LTD. and JAPAN ELECTRONIC MATERIALS CORPORATION, as assignee of the entire right, title and interest in and to the same, for the sole use and benefit of SHINKO ELECTRIC INDUSTRIES CO., LTD. and JAPAN ELECTRONIC MATERIALS CORPORATION, its successors and assigns.

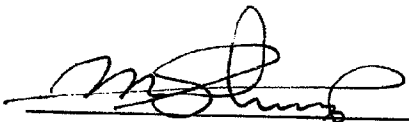
AND, said SHINKO ELECTRIC INDUSTRIES CO., LTD. and JAPAN ELECTRONIC MATERIALS CORPORATION, do hereby accept this Assignment with all its rights and obligations.

The undersigned hereby grants the firm of Rankin, Hill & Clark LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, the parties have signed this Assignment on the dates below written.

ASSIGNOR:

SHINKO ELECTRIC INDUSTRIES
CO., LTD.

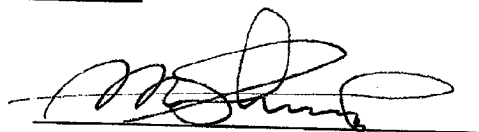


Name: Mr. Mitsuharu Shimizu
Title: President

Date: Jan. 28th '15

ASSIGNEE:

SHINKO ELECTRIC INDUSTRIES
CO., LTD.



Name: Mr. Mitsuharu Shimizu
Title: President


Date: Jan. 28th '15

ASSIGNEE:

JAPAN ELECTRONIC MATERIALS
CORPORATION

Name: Mr. Yasutaka Adachi
Title: General Manager of the
Administration Division

Date: _____



Feb. 13, 2015